

Structure Silicon monolithic integrated circuit

Product Name Sound Generator for cellular phone

Product No. BU8899GU

F e a t u r e s 64 polyphonic tones,128 sounds plus 47 drum set sounds, 15 electric drum set

sounds

Up to 8 user customized sound can be used to create original sounds.

○Absolute Maximum Ratings(unless otherwise noted, Ta = 25°C)

Parameter	Symbol	Rating	Unit	Remarks
Maximum I/O supply voltage	VDDIO	-0.3 ~ 4.5	V	DVDD_IO, AVDD
Maximum CORE supply voltage	VDDCO	-0.3 ~ 3.5	V	DVDD_CORE
Voltage applied to pin	VIN	DVSS-0.3 ~ VDDIO+0.3	V	
Input current	IIN	-1 ∼ +1	uA	
Allowable dissipation	Pd	1600 (*1)	mW	
Storage temperature range	Tstg	- 50 ∼ 125	°C	Array Array
Operating temperature range	Topr	-30 ∼ 85	°C	

(*1) Note: Reduce to 5.0mW/°C when Ta = 25°C or above

○Recommended Operating Power Supply Voltage Range(Unless otherwise noted, Ta = 25°C)

Parameter	Cumbal	rating					
rarameter	Symbol	Min	Тур	Max	Unit	Remarks	
I/O Power supply voltage	VDDIO	2.7	3.0	3.3	V	DVDD_IO, AVDD	
CORE Power supply voltage	VDDCO	2.25	2.5	2.75	V	DVDD_CORE	
Ambient temperature	Ta	-30	25	85	°C		
MCLK input frequency	FMCLK	2.688	-	20	MHz		
SCLK input frequency	FSCLK	-	-	20	MHz	Internal operation frequency / 2 or less	
MCLK duty	DMCLK	40	50	60	%		
Analog pin's load resistance	ZAN	10	-	-	kΩ		

This chip is not designed to protect itself against radioactive rays.

Status of this document

The Japanese version of this document is the formal specification. A customer may use this translation version only for a reference to help reading the formal version. If there are any differences in translation version of this document, formal version takes priority.

Application example

The product described in this specification is designed to be used with ordinary electronic equipment or devices(such as audio-visual equipment, office-automation equipment, communications devices, electrical appliances, and electronic toys). Should you intend to use this product with equipment or devices which require an extremely high level of reliability and the malfunction of which

Should you intend to use this product with equipment or devices which require an extremely high level of reliability and the malfunction of which would directly endanger human life(such as medical instruments,transportation equipment,aerospace machinery,nuclear-reactor controllers,fuel controllers and other safety devices),please be sure to consult with our sales representative in advance.



OElectrical Characteristics

(Unless otherwise noted, Ta = 25°C)

Parameter	Symbol	rating				0 1111		
raiametei	Symbol	Min	Тур	Max	Unit	Conditions		
Digital DC characteristics								
High-level input voltage	VIH	DVDD_	-	-	V			
	-	IO-0.5		D) (00				
Low-level input voltage	VIL	-	-	DVSS +0.5	٧			
High-level input voltage	IIH	-	-	1	μΑ	VIH=VDDIO		
Low-level input voltage	IIL	-1	-	-	μΑ	VIL=DVSS		
High-level output voltage	VOH	DVDD_ IO-0.3	-	- -	٧	IOH=-0.8mA		
Low-level output voltage	VOL	-	-	DVSS+	٧	IOL=0.8mA		
Analog DC characteristics						J		
VREF pin voltage	VAGND	0.475	0.5AVD	0.525	17	IOUT=0A(no load)		
VHEF pill voltage	VAGND	AVDD	D	AVDD	V			
Analog pin voltago	VOUT	0.47	0.5AVD	0.53	V	IOUT=0A(no load)		
Analog pin voltage		AVDD	D	AVDD		Not playing		
General characteristics								
VREF pin rise time	TRVR	-	15	25	mS	When CVREF = 1uF, NRST=L→H		
Analog pin characteristics								
Analog amplitude	VMAX	-	0.6 AVDD	-	Vp-p	Theoretical value for dynamic range		
Power consumption DVDD_CORE=2.5[V], DVDD_IO=3.0[V], AVDD=3.0[V], internal operation frequency SYS_CLK=50[MHz]								
Analog Idd1	AIDD1	-	1.5	2.5	mA	Playing		
Digital Idd10	DIDD10	-	28	35	mA	Not playing		
Digital luu 10						MIDI CLK control="101"		
Digital Idd11	DIDD44		50	05		Playing 64POLY		
(DVDD_CORE)	DIDD11	-	56	65	mA			
Digital Idd12	DIDD40		0.4			Playing		
(DVDD_IO)	DIDD12	-	0.4	1	mA			
Analog Idd2	AIDD2	-	-	1	μΑ	Standby mode		
Degital Idd20	Dinasa							
(DVDD_CORE)	DIDD20	-	•	10	μΑ	Standby mode		



○Pin layout diagram

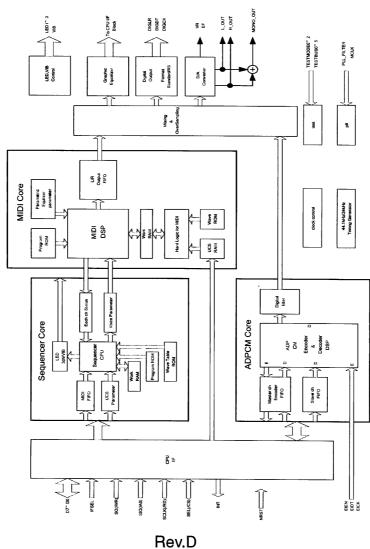
Pin NO.	Pin name	Pin NO.	Pin name	Pin NO.	Pin name
A2	VIB	НЗ	DVSS	F2	DIGDT
А3	INT	D8	TMODE2	G2	DIGCK
В3	LED1	E8	TMODE1	G6	TESTBUS0
A4	LED2	E7	TMODE0	Н6	TESTBUS1
B4	LED3	A7	DVDD_IO	H5	TESTBUS2
D7	D7	H1	DVDD_IO	G5	TESTBUS3
C8	D6	F8	R_OUT	H4	TESTBUS4
C7	D5	F7	VREF	G4	TESTBUS5
B8	D4	G8	L_OUT	G3	PLL_FILTER
B6	D3	G7	AVSS	G1	MCLK
A6	D2	H8	AVDD	E2	IFSEL
B5	D1	H7	MONO_OUT	E1	SO(/WR)
A5	D0	B2	EIEN	D1	SIO(/A0)
B7	DVDD_CORE	A1	EIDT	D2	SCLK(/RD)
H2	DVDD_CORE	B1	EICK	C1	SEL(/CS)
A8	DVSS	F1	DIGLR	C2	NRST

O Block diagram

0.82±0.1

VCSP85H5 (48Pin)

(Unit: mm)





Cautions on use

(1) Absolute Maximum Ratings

An excess in the absolute maximum ratings, such as supply voltage, temperature range of operating conditions, etc., can break down devices, thus making impossible to identify breaking mode such as a short circuit or an open circuit. If any special mode exceeding the absolute maximum ratings is assumed, consideration should be given to take physical safety measures including the use of fuses, etc.

(2) Operating conditions

These conditions represent a range within which characteristics can be provided approximately as expected. The electrical characteristics are guaranteed under the conditions of each parameter.

(3) Reverse connection of power supply connector

The reverse connection of power supply connector can break down ICs. Take protective measures against the breakdown due to the reverse connection, such as mounting an external diode between the power supply and the IC's power supply terminal.

(4) Power supply line

Design PCB pattern to provide low impedance for the wiring between the power supply and the GND lines.In this regard, for the digital block power supply and the analog block power supply, even though these power supplies has the same level of potential, separate the power supply pattern for the digital block from that for the analog block, thus suppressing the diffraction of digital noises to the analog block power supply resulting from impedance common to the wiring patterns. For the GND line, give consideration to design the patterns in a similar manner.

Furthermore, for all power supply terminals to ICs, mount a capacitor between the power supply and the GND terminal. At the same time, in order to use an electrolytic capacitor, thoroughly check to be sure the characteristics of the capacitor to be used present no problem including the occurrence of capacity dropout at a low temperature, thus determining the constant.

(5) GND voltage

Make setting of the potential of the GND terminal so that it will be maintained at the minimum in any operating state. Furthermore, check to be sure no terminals are at a potential lower than the GND voltage including an actual electric transient.

(6) Short circuit between terminals and erroneous mounting

In order to mount ICs on a set PCB, pay thorough attention to the direction and offset of the ICs. Erroneous mounting can break down the ICs. Furthermore, if a short circuit occurs due to foreign matters entering between terminals or between the terminal and the power supply or the GND terminal, the ICs can break down.

(7) Operation in strong electromagnetic field

Be noted that using ICs in the strong electromagnetic field can malfunction them.

(8) Inspection with set PCB

On the inspection with the set PCB, if a capacitor is connected to a low-impedance IC terminal, the IC can suffer stress. Therefore, be sure to discharge from the set PCB by each process. Furthermore, in order to mount or dismount the set PCB to/from the jig for the inspection process, be sure to turn OFF the power supply and then mount the set PCB to the jig. After the completion of the inspection, be sure to turn OFF the power supply and then dismount it from the jig. In addition, for protection against static electricity, establish a ground for the assembly process and pay thorough attention to the transportation and the storage of the set PCB.

(9)Input terminals

In terms of the construction of IC, parasitic elements are inevitably formed in relation to potential. The operation of the parasitic element can cause interference with circuit operation, thus resulting in a malfunction and then breakdown of the input terminal. Therefore, pay thorough attention not to handle the input terminals, such as to apply to the input terminals a voltage lower than the GND respectively, so that any parasitic element will operate. Furthermore, do not apply a voltage to the input terminals when no power supply voltage is applied to the IC. In addition, even if the power supply voltage is applied, apply to the input terminals a voltage lower than the power supply voltage or within the guaranteed value of electrical characteristics.

(10) Ground wiring pattern

If small-signal GND and large-current GND are provided, it will be recommended to separate the large-current GND pattern from the small-signal GND pattern and establish a single ground at the reference point of the set PCB so that resistance to the wiring pattern and voltage fluctuations due to a large current will cause no fluctuations in voltages of the small-signal GND. Pay attention not to cause fluctuations in the GND wiring pattern of external parts as well.

(11) External capacitor

In order to use a ceramic capacitor as the external capacitor, determine the constant with consideration given to a degradation in the nominal capacitance due to DC bias and changes in the capacitance due to temperature, etc.

(12) Others

In case of use this LSI, please peruse some other detail documents, we called ,Technical note, Functinal description, Application note.

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```
U.S.A / San Diego
                        TEL: +1(858)625-3630
                                                 FAX: +1(858)625-3670
       Atlanta
                        TEL: +1(770)754-5972
                                                 FAX: +1(770)754-0691
       Dallas
                        TEL: +1(972)312-8818
                                                 FAX: +1(972)312-0330
Germany / Dusseldorf
                        TEL: +49(2154)9210
                                                 FAX: +49(2154)921400
United Kingdom / London TEL: +44(1)908-282-666
                                                 FAX: +44(1)908-282-528
France / Paris
                        TEL: +33(0)1 56 97 30 60 FAX: +33(0) 1 56 97 30 80
China / Hong Kong
                        TEL: +852(2)740-6262
                                                 FAX: +852(2)375-8971
       Shanghai
                        TEL: +86(21)6279-2727
                                                 FAX: +86(21)6247-2066
       Dilian
                        TEL: +86(411)8230-8549
                                                 FAX: +86(411)8230-8537
       Beijing
                        TEL: +86(10)8525-2483
                                                 FAX: +86(10)8525-2489
Taiwan / Taipei
                        TEL: +866(2)2500-6956
                                                 FAX: +866(2)2503-2869
Korea / Seoul
                        TEL: +82(2)8182-700
                                                 FAX: +82(2)8182-715
Singapore
                        TEL: +65-6332-2322
                                                 FAX: +65-6332-5662
Malaysia / Kuala Lumpur
                        TEL: +60(3)7958-8355
                                                 FAX: +60(3)7958-8377
Philippines / Manila
                        TEL: +63(2)807-6872
                                                 FAX: +63(2)809-1422
Thailand / Bangkok
                        TEL: +66(2)254-4890
                                                 FAX: +66(2)256-6334
```

Japan / (Internal Sales)

Tokyo 2-1-1, Yaesu, Chuo-ku, Tokyo 104-0082

TEL: +81(3)5203-0321 FAX: +81(3)5203-0300

Yokohama 2-4-8, Shin Yokohama, Kohoku-ku, Yokohama, Kanagawa 222-8575

TEL: +81(45)476-2131 FAX: +81(45)476-2128

Nagoya Dainagayo Building 9F 3-28-12, Meieki, Nakamura-ku, Nagoya, Aichi 450-0002

TEL: +81(52)581-8521 FAX: +81(52)561-2173

Kyoto 579-32 Higashi Shiokouji-cho, Karasuma Nishi-iru, Shiokoujidori, Shimogyo-ku,

Kyoto 600-8216

TEL: +81(75)311-2121 FAX: +81(75)314-6559

(Contact address for overseas customers in Japan)

Yokohama TEL: +81(45)476-9270 FAX: +81(045)476-9271